# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





### TRENCHSTOP<sup>™</sup> Series

#### Low Loss DuoPack : IGBT in TRENCHSTOP<sup>TM</sup> and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode

- Very low V<sub>CE(sat)</sub> 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs
  - Designed for:
    - Frequency Converters
    - Drives
  - TRENCHSTOP<sup>TM</sup> and Fieldstop technology for 600V applications offers:
    - very tight parameter distribution
    - high ruggedness, temperature stable behavior
    - very high switching speed
    - Iow V<sub>CE(sat)</sub>
- Positive temperature coefficient in V<sub>CE(sat)</sub>
- Low EMI

•

- Low Gate Charge
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC<sup>1)</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <u>http://www.infineon.com/igbt/</u>

Туре	V <sub>CE</sub>	<i>I</i> c	V <sub>CE(sat),Tj=25℃</sub>	<b>T</b> <sub>j,max</sub>	Marking	Package
IKP04N60T	600V	4A	1.5V	175°C	K04T60	PG-TO220-3

#### **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V <sub>CE</sub>	600	V
DC collector current, limited by $T_{jmax}$ $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	I <sub>C</sub>	9.5 6.5	
Pulsed collector current, $t_p$ limited by $T_{jmax}$	I <sub>Cpuls</sub>	12	•
Turn off safe operating area, $V_{CE} = 600V$ , $T_j = 175^{\circ}C$ , $t_p = 1\mu s$	-	12	— A
Diode forward current, limited by Tjmax $T_{\rm C} = 25^{\circ}{\rm C}$ $T_{\rm C} = 100^{\circ}{\rm C}$	I <sub>F</sub>	9.5 6.5	
Diode pulsed current, $t_p$ limited by $T_{jmax}$	I <sub>Fpuls</sub>	12	
Gate-emitter voltage	V <sub>GE</sub>	±20	V
Short circuit withstand time <sup>2)</sup> $V_{GE} = 15V, V_{CC} \le 400V, T_j \le 150^{\circ}C$	tsc	5	μS
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	Ptot	42	W
Operating junction temperature	Tj	-40+175	
Storage temperature	T <sub>stg</sub>	-55+150	°C
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

<sup>1)</sup> J-STD-020 and JESD-022

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.





RoHS



### TRENCHSTOP<sup>™</sup> Series

#### **Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	0		0.5	
junction – case	$R_{ m thJC}$		3.5	
Diode thermal resistance,	D			
junction – case	$R_{ m thJCD}$		5	K/W
Thermal resistance,			60	1
junction – ambient	$R_{ m thJA}$		62	

#### **Electrical Characteristic,** at $T_j = 25^{\circ}C$ , unless otherwise specified

Deveryotar	Cumula al	O a maliti a ma	Value			11	
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit	
Static Characteristic		·					
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE} = 0  \rm V, \ I_{\rm C} = 0.2  \rm m  A$	600	-	-		
		$V_{\rm GE} = 15 \rm V, \ I_{\rm C} = 4 \rm A$					
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	<i>T</i> <sub>j</sub> =25°C	-	1.5	2.05		
		<i>T</i> <sub>j</sub> =175°C	-	1.9	-		
Diada famuand calkana		$V_{GE}=0V, I_{F}=4A$				V	
Diode forward voltage	VF	<i>T</i> <sub>j</sub> =25°C	-	1.65	2.05		
		<i>T</i> <sub>j</sub> =175°C	-	1.6	-		
Gate-emitter threshold voltage	V <sub>GE(th)</sub>	$I_{\rm C}=60\mu {\rm A}, V_{\rm CE}=V_{\rm GE}$	4.1	4.9	5.7		
		$V_{\rm CE} = 600  \text{V}, \ V_{\rm GE} = 0  \text{V}$					
Zero gate voltage collector current	ICES	<i>T</i> <sub>j</sub> =25°C					
		<i>T</i> <sub>j</sub> =175°C	-	-	40	μA	
			-	-	1000		
Gate-emitter leakage current	IGES	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA	
Transconductance	$g_{ m fs}$	$V_{\rm CE} = 20  \text{V}, \ I_{\rm C} = 4  \text{A}$	-	2.2	-	S	
Integrated gate resistor	R <sub>Gint</sub>			-	•	Ω	

#### Dynamic Characteristic

Input capacitance	Cies	V <sub>CE</sub> =25V,	-	252	-	
Output capacitance	Coes	$V_{\rm GE}=0V$ ,	-	20	-	pF
Reverse transfer capacitance	Cres	f=1MHz	-	7.5	-	
Gate charge	$Q_{Gate}$	V <sub>CC</sub> =480V, I <sub>C</sub> =4A V <sub>GE</sub> =15V	-	27	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	LE		-	7	-	nH
Short circuit collector current <sup>1)</sup>	I <sub>C(SC)</sub>	$V_{GE} = 15V, t_{SC} \le 5\mu s$ $V_{CC} = 400V, T_j \le 150^{\circ}C$	-	36	-	A

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.



### TRENCHSTOP<sup>™</sup> Series

Paramotor	Symbol	Conditions	Value			Limit
Parameter	Symbol		min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t <sub>d(on)</sub>	<i>T</i> <sub>j</sub> =25°C,	-	14	-	
Rise time	t <sub>r</sub>	$V_{\rm CC} = 400  \text{V}, I_{\rm C} = 4  \text{A},$	-	7	-	1
Turn-off delay time	$t_{d(off)}$	$V_{\rm GE} = 0/15 V,$ $R_{\rm G} = 47 \Omega,$	-	164	-	ns
Fall time	t <sub>f</sub>	$L_{\sigma}^{(1)} = 150 \text{nH},$	-	43	-	
Turn-on energy	Eon	$C_{\sigma}^{(1)} = 47 \text{pF}$	-	61	-	
Turn-off energy	E <sub>off</sub>	Energy losses include "tail" and diode	-	84	-	μJ
Total switching energy	Ets	reverse recovery.	-	145	-	
Anti-Parallel Diode Characteristic		·				
Diode reverse recovery time	t <sub>rr</sub>	<i>T</i> <sub>j</sub> =25°C,	-	28	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	$V_{\rm R}$ =400V, $I_{\rm F}$ =4A,	-	79	-	nC
Diode peak reverse recovery current	<i>I</i> <sub>rrm</sub>	di <sub>F</sub> /dt=610A/µs	-	5.3	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	346	-	A/µs

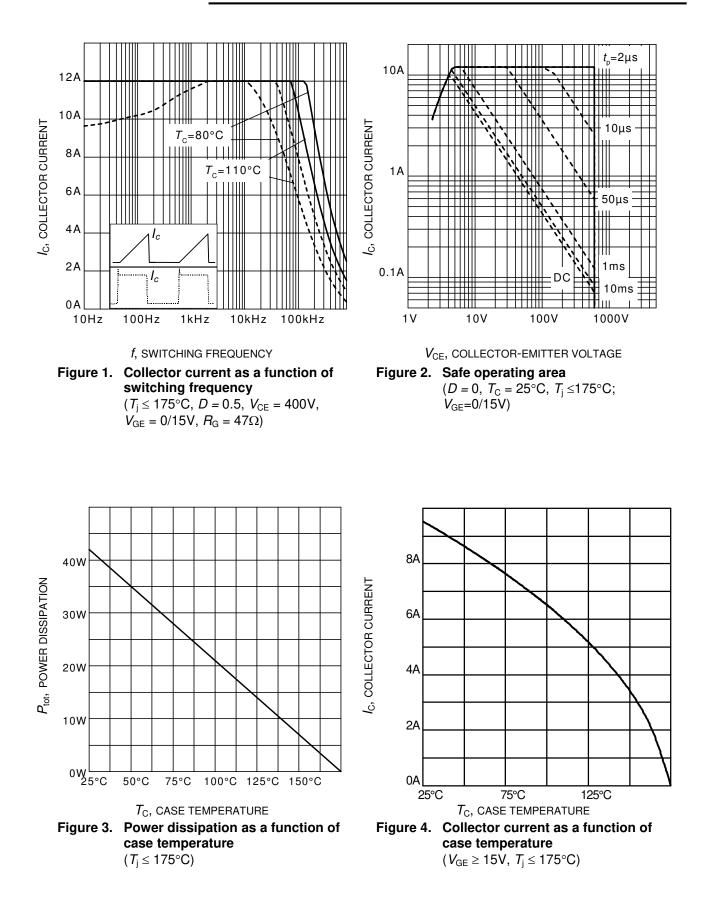
#### Switching Characteristic, Inductive Load, at $T_i=25$ °C

#### Switching Characteristic, Inductive Load, at $T_j=175^{\circ}C$

Devenuedev	Ourseland	O a su all'il la su a	Value			
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t <sub>d(on)</sub>	<i>T</i> <sub>j</sub> =175°C,	-	14	-	
Rise time	t <sub>r</sub>	$V_{\rm CC} = 400  \text{V}, I_{\rm C} = 4  \text{A},$	-	10	-	1
Turn-off delay time	t <sub>d(off)</sub>	$V_{\rm GE} = 0/15 \rm V,$ $R_{\rm G} = 47 \Omega$	-	185	-	ns
Fall time	t <sub>f</sub>	$L_{\sigma}^{(1)} = 150 \text{ nH},$ $C_{\sigma}^{(1)} = 47 \text{ pF}$	-	83	-	1
Turn-on energy	Eon		-	99	-	
Turn-off energy	E <sub>off</sub>	Energy losses include "tail" and diode	-	97	-	μJ
Total switching energy	Ets	reverse recovery.	-	196	-	
Anti-Parallel Diode Characteristic	1	1				
Diode reverse recovery time	t <sub>rr</sub>	<i>T</i> <sub>i</sub> =175°C	-	95	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	$V_{\rm R}$ =400V, $I_{\rm F}$ =4A,	-	291	-	nC
Diode peak reverse recovery current	<i>I</i> <sub>rrm</sub>	di <sub>F</sub> /dt=610A/µs	-	6.6	-	Α
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	253	-	A/μs

 $^{1)}$  Leakage inductance  $L_{\sigma}$  and Stray capacity  $\mathcal{C}_{\sigma}$  due to dynamic test circuit in Figure E.

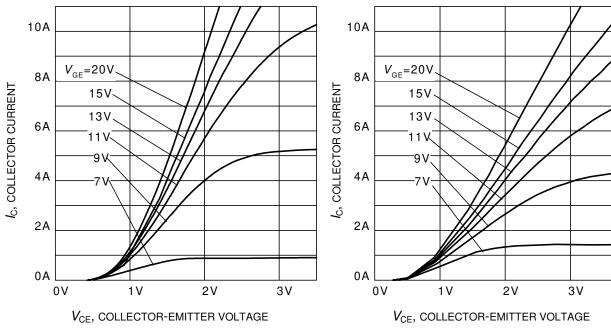


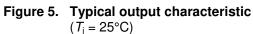


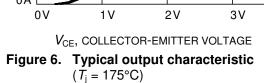


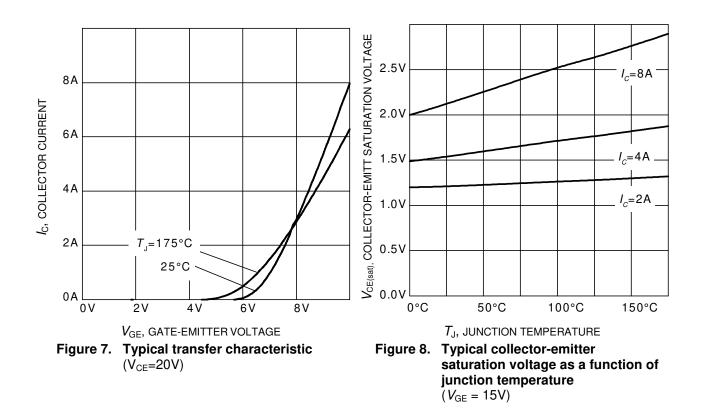


TRENCHSTOP<sup>™</sup> Series

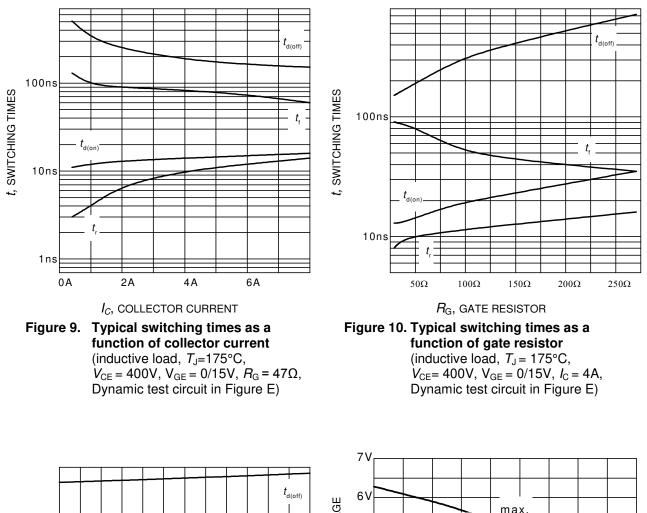


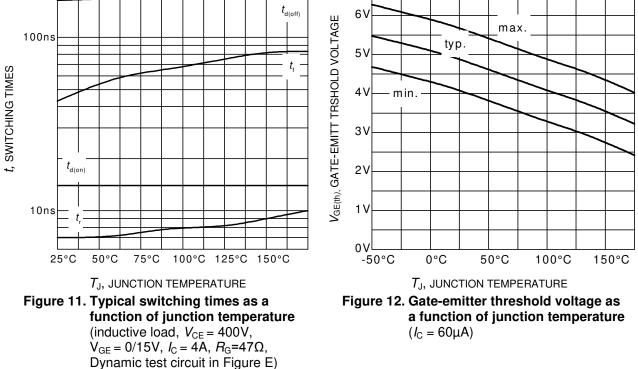






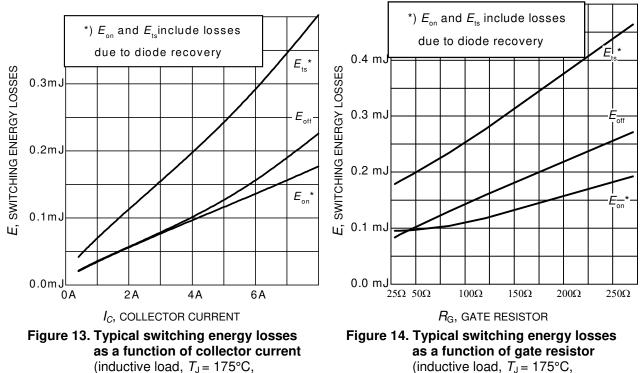




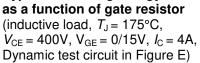


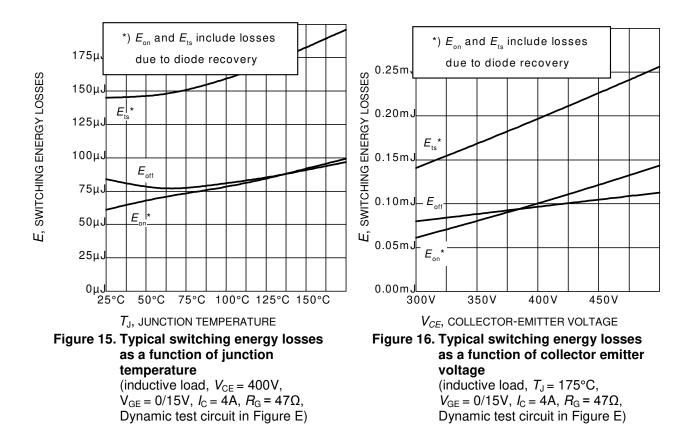


### TRENCHSTOP<sup>™</sup> Series



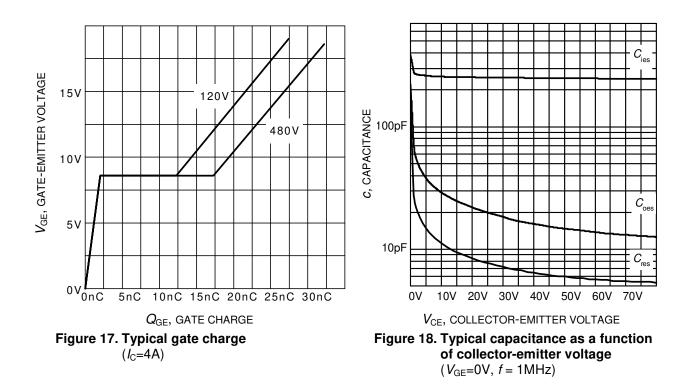
 $V_{CE} = 400V, V_{GE} = 0/15V, R_G = 47\Omega,$ Dynamic test circuit in Figure E)

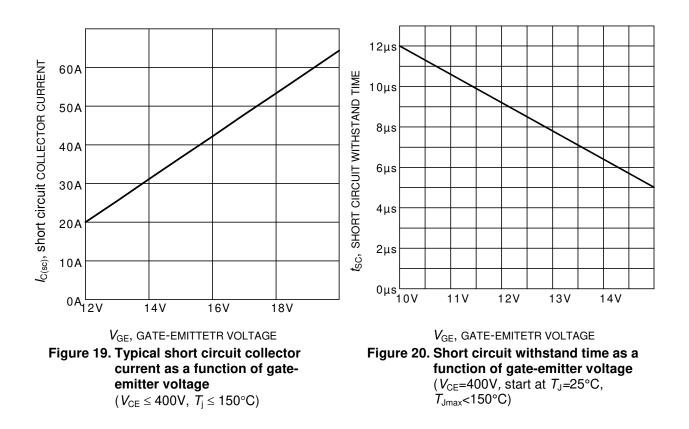




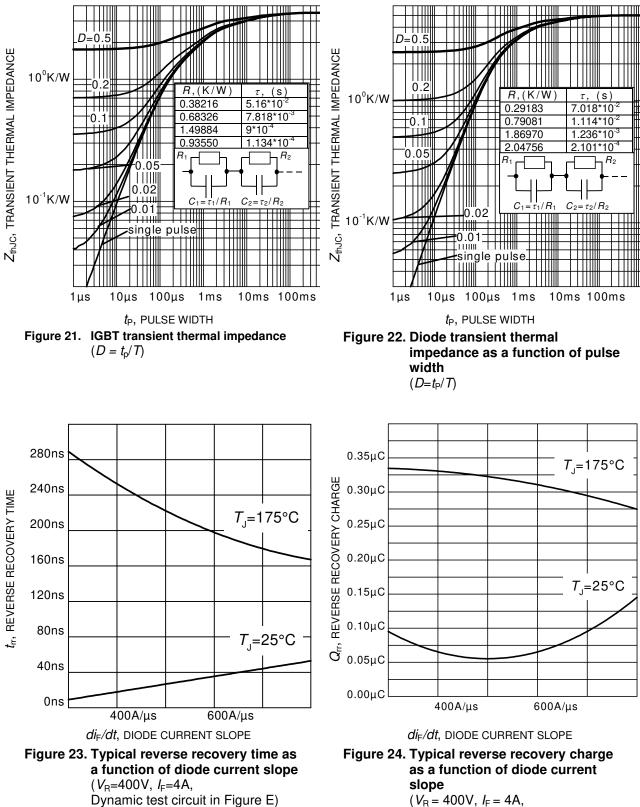


TRENCHSTOP<sup>™</sup> Series

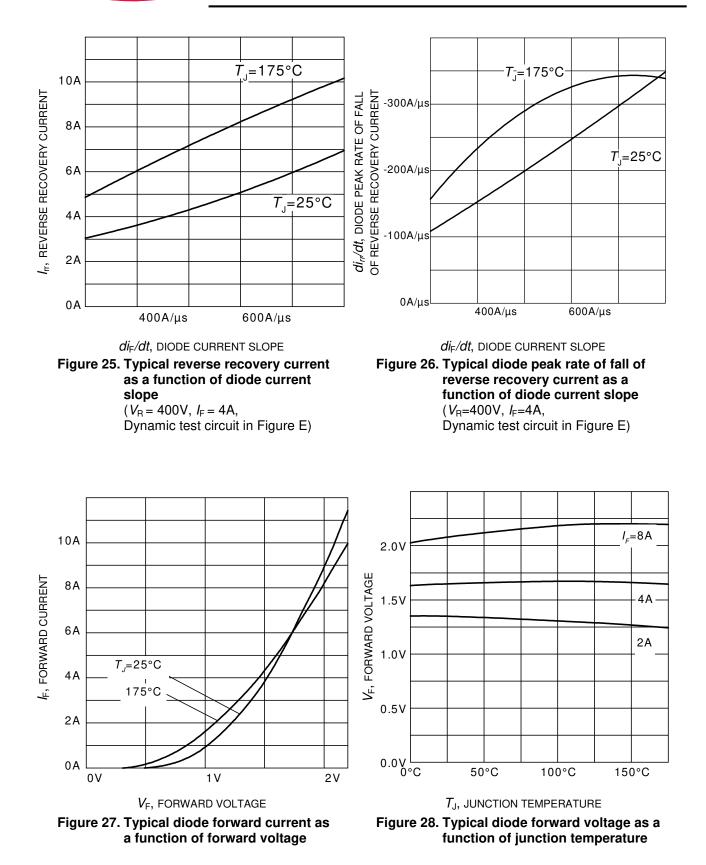








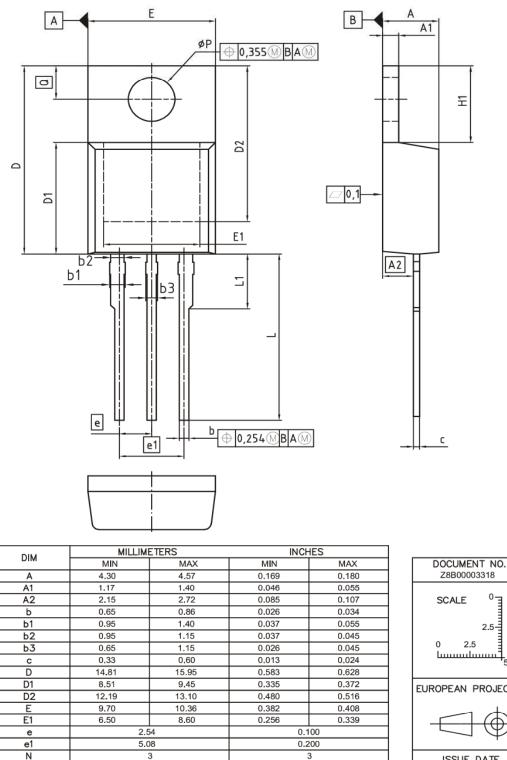


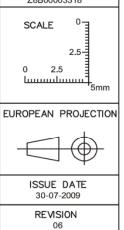




TRENCHSTOP<sup>™</sup> Series

### Package Drawing PG-TO220-3





H1

L

L1

øP

Q

5,90

13.00

3.60

2.60

0.232

0.512

0.142

0.102

0,272

0.551

0.189

0.153

0.118

6,90

14.00

4.80

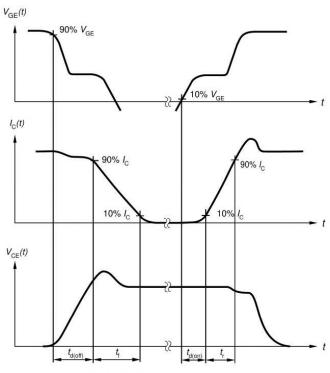
3.89

3.00

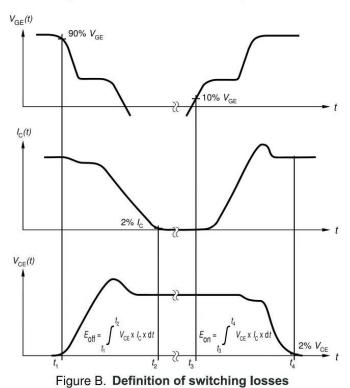


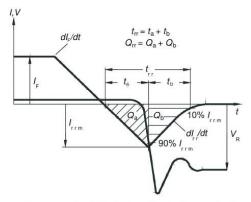
### TRENCHSTOP<sup>™</sup> Series

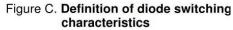
#### **Testing Conditions**











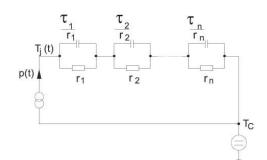


Figure D. Thermal equivalent circuit

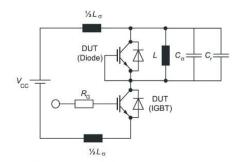


Figure E. Dynamic test circuit Parasitic inductance  $L_{\sigma}$ , parasitic capacitor  $C_{\sigma}$ , relief capacitor  $C_{r}$ , (only for ZVT switching)



Published by Infineon Technologies AG 81726 München, Germany © Infineon Technologies AG 2016. All Rights Reserved.

#### **IMPORTANT NOTICE**

The information given in this document shall in <u>no event</u> be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie"). With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (www.infineon.com).

Please note that this product is <u>not</u> qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

#### **WARNINGS**

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may <u>not</u> be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.